

## 3-PHASE BRIDGE DRIVER

### Features

- Floating channel designed for bootstrap operation  
Fully operational to +600V  
Tolerant to negative transient voltage  
dV/dt immune
- Gate drive supply range from 10 to 20V
- Undervoltage lockout for all channels
- Over-current shutdown turns off all six drivers
- Independent half-bridge drivers
- Matched propagation delay for all channels
- Outputs out of phase with inputs

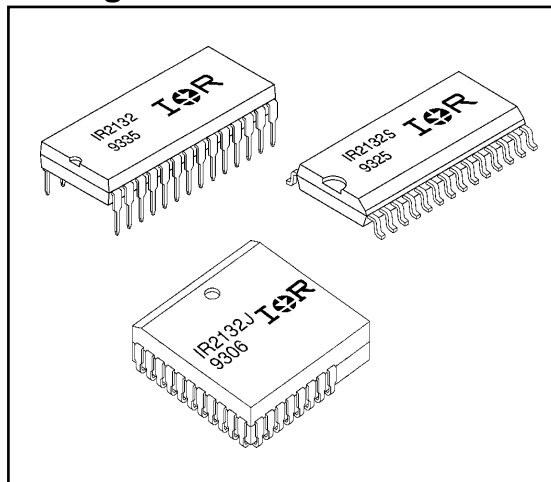
### Description

The IR2132 is a high voltage, high speed power MOSFET and IGBT driver with three independent high and low side referenced output channels. Proprietary HVIC technology enables ruggedized monolithic construction. Logic inputs are compatible with 5V CMOS or LSTTL outputs. A ground-referenced operational amplifier provides analog feedback of bridge current via an external current sense resistor. A current trip function which terminates all six outputs is also derived from this resistor. An open drain FAULT signal indicates if an over-current or undervoltage shutdown has occurred. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. Propagation delays are matched to simplify use at high frequencies. The floating channels can be used to drive N-channel power MOSFETs or IGBTs in the high side configuration which operate up to 600 volts.

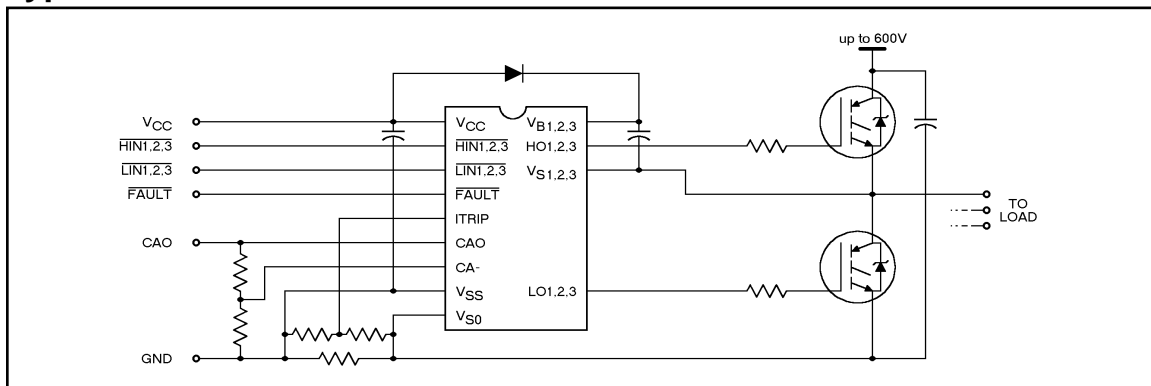
### Product Summary

$V_{\text{OFFSET}}$	600V max.
$I_{\text{O+/-}}$	200 mA / 420 mA
$V_{\text{OUT}}$	10 - 20V
$t_{\text{on/off (typ.)}}$	675 & 425 ns
Deadtime (typ.)	0.8 $\mu\text{s}$

### Packages



### Typical Connection



## Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to  $V_{S0}$ . The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions. Additional information is shown in Figures 50 through 53.

Symbol	Parameter Definition	Value		Units
		Min.	Max.	
$V_{B1,2,3}$	High Side Floating Supply Voltage	-0.3	525	V
$V_{S1,2,3}$	High Side Floating Offset Voltage	$V_{B1,2,3} - 25$	$V_{B1,2,3} + 0.3$	
$V_{HO1,2,3}$	High Side Floating Output Voltage	$V_{S1,2,3} - 0.3$	$V_{B1,2,3} + 0.3$	
$V_{CC}$	Low Side and Logic Fixed Supply Voltage	-0.3	25	
$V_{SS}$	Logic Ground	$V_{CC} - 25$	$V_{CC} + 0.3$	
$V_{LO1,2,3}$	Low Side Output Voltage	-0.3	$V_{CC} + 0.3$	
$V_{IN}$	Logic Input Voltage ( $\overline{HIN1,2,3}$ , $\overline{LIN1,2,3}$ & ITRIP)	$V_{SS} - 0.3$	$V_{CC} + 0.3$	
$V_{FLT}$	$\overline{FAULT}$ Output Voltage	$V_{SS} - 0.3$	$V_{CC} + 0.3$	
$V_{CAO}$	Operational Amplifier Output Voltage	$V_{SS} - 0.3$	$V_{CC} + 0.3$	
$V_{CA-}$	Operational Amplifier Inverting Input Voltage	$V_{SS} - 0.3$	$V_{CC} + 0.3$	
$dV_S/dt$	Allowable Offset Supply Voltage Transient	—	50	V/ns
$P_D$	Package Power Dissipation @ $T_A \leq +25^\circ\text{C}$ (28 Lead DIP)	—	1.5	W
	(28 Lead SOIC)	—	1.6	
	(44 Lead PLCC)	—	2.0	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (28 Lead DIP)	—	83	$^\circ\text{C}/\text{W}$
	(28 Lead SOIC)	—	78	
	(44 Lead PLCC)	—	63	
$T_J$	Junction Temperature	—	150	$^\circ\text{C}$
$T_S$	Storage Temperature	-55	150	
$T_L$	Lead Temperature (Soldering, 10 seconds)	—	300	

## Recommended Operating Conditions

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. All voltage parameters are absolute voltages referenced to  $V_{S0}$ . The  $V_S$  offset rating is tested with all supplies biased at 15V differential. Typical ratings at other bias conditions are shown in Figure 54.

Symbol	Parameter Definition	Value		Units
		Min.	Max.	
$V_{B1,2,3}$	High Side Floating Supply Voltage	$V_{S1,2,3} + 10$	$V_{S1,2,3} + 20$	V
$V_{S1,2,3}$	High Side Floating Offset Voltage	Note 1	600	
$V_{HO1,2,3}$	High Side Floating Output Voltage	$V_{S1,2,3}$	$V_{B1,2,3}$	
$V_{CC}$	Low Side and Logic Fixed Supply Voltage	10	20	
$V_{SS}$	Logic Ground	-5	5	
$V_{LO1,2,3}$	Low Side Output Voltage	0	$V_{CC}$	
$V_{IN}$	Logic Input Voltage ( $\overline{HIN1,2,3}$ , $\overline{LIN1,2,3}$ & ITRIP)	$V_{SS}$	$V_{SS} + 5$	
$V_{FLT}$	$\overline{FAULT}$ Output Voltage	$V_{SS}$	$V_{CC}$	
$V_{CAO}$	Operational Amplifier Output Voltage	$V_{SS}$	5	
$V_{CA-}$	Operational Amplifier Inverting Input Voltage	$V_{SS}$	5	
$T_A$	Ambient Temperature	-40	125	$^\circ\text{C}$

Note 1: Logic operational for  $V_S$  of  $(V_{S0} - 5V)$  to  $(V_{S0} + 600V)$ . Logic state held for  $V_S$  of  $(V_{S0} - 5V)$  to  $(V_{S0} - V_{BS})$ .

## Dynamic Electrical Characteristics

$V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS1,2,3}$ ) = 15V,  $V_{S0,1,2,3}$  =  $V_{SS}$ ,  $C_L$  = 1000 pF and  $T_A$  = 25°C unless otherwise specified. The dynamic electrical characteristics are defined in Figures 3 through 5.

Symbol	Parameter Definition	Figure	Value			Units	Test Conditions
			Min.	Typ.	Max.		
$t_{on}$	Turn-On Propagation Delay	11	500	675	850	ns	$V_{IN} = 0$ & 5V $V_{S1,2,3} = 0$ to 600V
$t_{off}$	Turn-Off Propagation Delay	12	300	425	550		
$t_r$	Turn-On Rise Time	13	—	80	125		
$t_f$	Turn-Off Fall Time	14	—	35	55		
$t_{itrip}$	ITRIP to Output Shutdown Prop. Delay	15	400	660	920		
$t_{bl}$	ITRIP Blanking Time	—	—	400	—		
$t_{fit}$	ITRIP to FAULT Indication Delay	16	335	590	845		
$t_{fit,in}$	Input Filter Time (All Six Inputs)	—	—	310	—	μs	$V_{IN}$ : $V_{ITRIP} = 0$ & 5V $V_{IN} = 0$ & 5V
$t_{fitclr}$	LIN1,2,3 to FAULT Clear Time	17	6.0	9.0	12.0		
DT	Deadtime	18	0.4	0.8	1.2	V/μs	$V_{IN} = 0$ & 5V
SR+	Operational Amplifier Slew Rate (+)	19	4.4	6.2	—		
SR-	Operational Amplifier Slew Rate (-)	20	2.4	3.2	—		

## Static Electrical Characteristics

$V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS1,2,3}$ ) = 15V,  $V_{S0,1,2,3}$  =  $V_{SS}$  and  $T_A$  = 25°C unless otherwise specified. The  $V_{IN}$ ,  $V_{TH}$  and  $I_{IN}$  parameters are referenced to  $V_{SS}$  and are applicable to all six logic input leads: HIN1,2,3 & LIN1,2,3. The  $V_O$  and  $I_O$  parameters are referenced to  $V_{S0,1,2,3}$  and are applicable to the respective output leads: HO1,2,3 or LO1,2,3.

Symbol	Parameter Definition	Figure	Value			Units	Test Conditions
			Min.	Typ.	Max.		
$V_{IH}$	Logic "0" Input Voltage (OUT = LO)	21	2.2	—	—	V	
$V_{IL}$	Logic "1" Input Voltage (OUT = HI)	22	—	—	0.8		
$V_{IT,TH+}$	ITRIP Input Positive Going Threshold	23	400	490	580	mV	$V_{IN} = 0V$ , $I_O = 0A$ $V_{IN} = 5V$ , $I_O = 0A$
$V_{OH}$	High Level Output Voltage, $V_{BIAS} - V_O$	24	—	—	100		
$V_{OL}$	Low Level Output Voltage, $V_O$	25	—	—	100	μA	$V_B = V_S = 600V$ $V_{IN} = 0V$ or 5V
$I_{LK}$	Offset Supply Leakage Current	26	—	—	50		
$I_{QBS}$	Quiescent $V_{BS}$ Supply Current	27	—	15	30	mA	$V_{IN} = 0V$ or 5V
$I_{QCC}$	Quiescent $V_{CC}$ Supply Current	28	—	3.0	4.0		
$I_{IN+}$	Logic "1" Input Bias Current (OUT = HI)	29	—	450	650	μA	$V_{IN} = 0V$ $V_{IN} = 5V$
$I_{IN-}$	Logic "0" Input Bias Current (OUT = LO)	30	—	225	400		
$I_{ITRIP+}$	"High" ITRIP Bias Current	31	—	75	150	nA	ITRIP = 5V ITRIP = 0V
$I_{ITRIP-}$	"Low" ITRIP Bias Current	32	—	—	100		
$V_{BSUV+}$	$V_{BS}$ Supply Undervoltage Positive Going Threshold	33	7.5	8.35	9.2	V	
$V_{BSUV-}$	$V_{BS}$ Supply Undervoltage Negative Going Threshold	34	7.1	7.95	8.8		
$V_{CCUV+}$	$V_{CC}$ Supply Undervoltage Positive Going Threshold	35	8.3	9.0	9.7		
$V_{CCUV-}$	$V_{CC}$ Supply Undervoltage Negative Going Threshold	36	8.0	8.7	9.4		
$R_{on,FLT}$	FAULT Low On-Resistance	37	—	55	75		

## Static Electrical Characteristics -- Continued

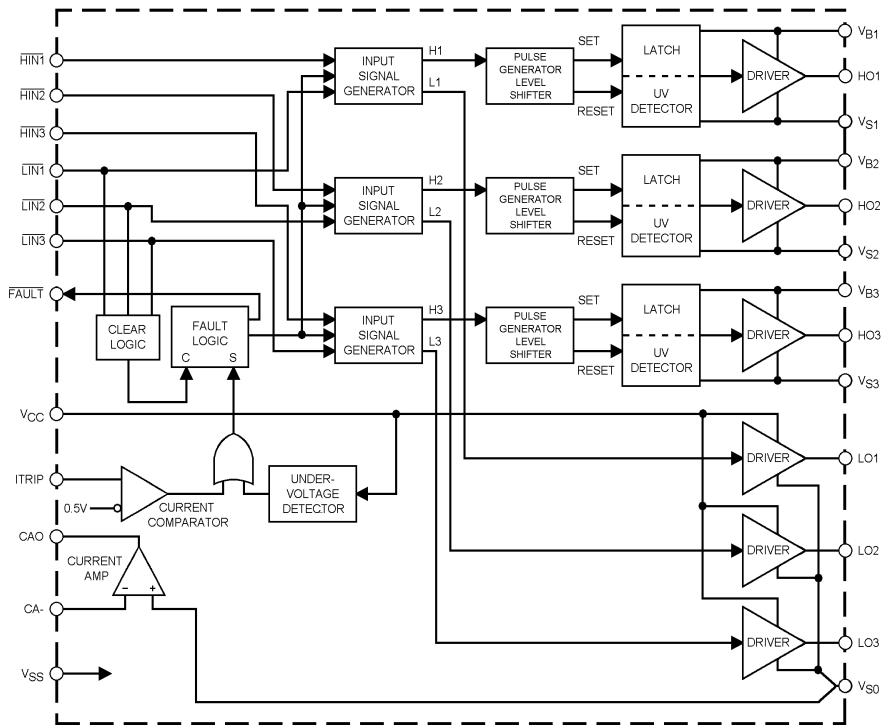
$V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS1,2,3}$ ) = 15V,  $V_{S0,1,2,3}$  =  $V_{SS}$  and  $T_A$  = 25°C unless otherwise specified. The  $V_{IN}$ ,  $V_{TH}$  and  $I_{IN}$  parameters are referenced to  $V_{SS}$  and are applicable to all six logic input leads:  $HIN1,2,3$  &  $LIN1,2,3$ . The  $V_O$  and  $I_O$  parameters are referenced to  $V_{S0,1,2,3}$  and are applicable to the respective output leads:  $HO1,2,3$  or  $LO1,2,3$ .

Symbol	Parameter Definition	Figure	Value			Units	Test Conditions
			Min.	Typ.	Max.		
$I_{O+}$	Output High Short Circuit Pulsed Current	38	200	250	—	mA	$V_O = 0V, V_{IN} = 0V$ $PW \leq 10 \mu s$
$I_{O-}$	Output Low Short Circuit Pulsed Current	39	420	500	—		$V_O = 15V, V_{IN} = 5V$ $PW \leq 10 \mu s$
$V_{OS}$	Operational Amplifier Input Offset Voltage	40	—	—	30	mV	$V_{S0} = V_{CA-} = 0.2V$
$I_{CA-}$	CA- Input Bias Current	41	—	—	4.0	nA	$V_{CA-} = 2.5V$
CMRR	Op. Amp. Common Mode Rejection Ratio	42	60	80	—	dB	$V_{S0} = V_{CA-} = 0.1V$ & 5V
PSRR	Op. Amp. Power Supply Rejection Ratio	43	55	75	—		$V_{S0} = V_{CA-} = 0.2V$ $V_{CC} = 10V$ & 20V
$V_{OH,AMP}$	Op. Amp. High Level Output Voltage	44	5.0	5.2	5.4	V	$V_{CA-} = 0V, V_{S0} = 1V$
$V_{OL,AMP}$	Op. Amp. Low Level Output Voltage	45	—	—	20	mV	$V_{CA-} = 1V, V_{S0} = 0V$
$I_{SRC,AMP}$	Op. Amp. Output Source Current	46	2.3	4.0	—	mA	$V_{CA-} = 0V, V_{S0} = 1V$ $V_{CAO} = 4V$
$I_{SRC,AMP}$	Op. Amp. Output Sink Current	47	1.0	2.1	—		$V_{CA-} = 1V, V_{S0} = 0V$ $V_{CAO} = 2V$
$I_{O+,AMP}$	Operational Amplifier Output High Short Circuit Current	48	—	4.5	6.5		$V_{CA-} = 0V, V_{S0} = 5V$ $V_{CAO} = 0V$
$I_{O-,AMP}$	Operational Amplifier Output Low Short Circuit Current	49	—	3.2	5.2		$V_{CA-} = 5V, V_{S0} = 0V$ $V_{CAO} = 5V$

## Lead Assignments

<p>28 Lead DIP</p>	<p>44 Lead PLCC w/o 12 Leads</p>	<p>28 Lead SOIC (Wide Body)</p>
<b>IR2132</b>	<b>IR2132J</b>	<b>IR2132S</b>
<b>Part Number</b>		

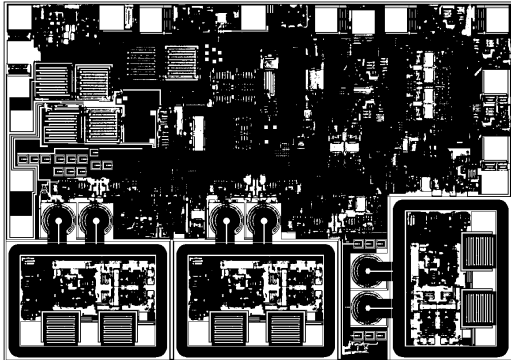
## Functional Block Diagram

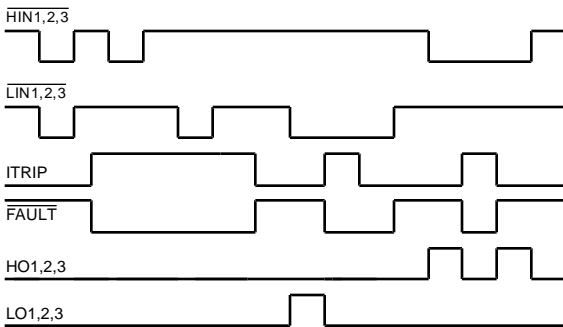


## Lead Definitions

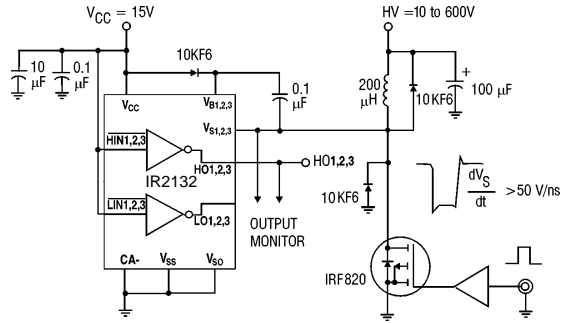
Symbol	Description
HIN1,2,3	Logic inputs for high side gate driver outputs (HO1,2,3), out of phase
LIN1,2,3	Logic inputs for low side gate driver output (LO1,2,3), out of phase
FAULT	Indicates over-current or undervoltage lockout (low side) has occurred, negative logic
V <sub>CC</sub>	Low side and logic fixed supply
ITRIP	Input for over-current shutdown
CAO	Output of current amplifier
CA-	Negative input of current amplifier
V <sub>SS</sub>	Logic ground
V <sub>B1,2,3</sub>	High side floating supplies
HO1,2,3	High side gate drive outputs
V <sub>S1,2,3</sub>	High side floating supply returns
LO1,2,3	Low side gate drive outputs
V <sub>S0</sub>	Low side return and positive input of current amplifier

## Device Information

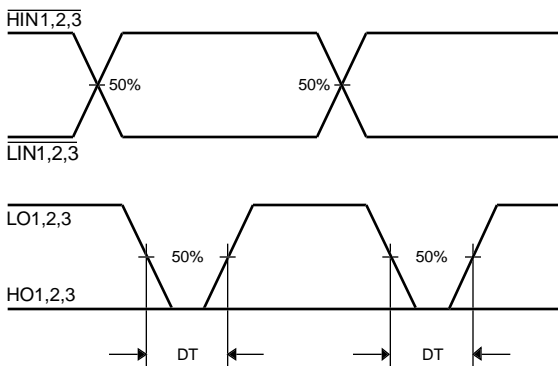
Process & Design Rule		HVDCMOS 4.0 $\mu$ m
Transistor Count		700
Die Size		126 X 175 X 26 (mil)
Die Outline		
Thickness of Gate Oxide		800Å
Connections	Material	Poly Silicon
	First Layer	Width Spacing Thickness
		4 $\mu$ m 6 $\mu$ m 5000Å
Second Layer	Material	Al - Si (Si: 1.0% $\pm$ 0.1%)
	Width	6 $\mu$ m
	Spacing	9 $\mu$ m
	Thickness	20,000Å
Contact Hole Dimension		8 $\mu$ m X 8 $\mu$ m
Insulation Layer	Material	PSG (SiO <sub>2</sub> )
	Thickness	1.5 $\mu$ m
Passivation (1)	Material	PSG (SiO <sub>2</sub> )
	Thickness	1.5 $\mu$ m
Passivation (2)	Material	Proprietary*
	Thickness	Proprietary*
Method of Saw		Full Cut
Method of Die Bond		Ablebond 84 - 1
Wire Bond	Method	Thermo Sonic
	Material	Au (1.0 mil / 1.3 mil)
Leadframe	Material	Cu
	Die Area	Ag
	Lead Plating	Pb : Sn (37 : 63)
Package	Types	28 Lead PDIP & SOIC / 44 Lead PLCC
	Materials	EME6300 / MP150 / MP190
Remarks: * Patent Pending		



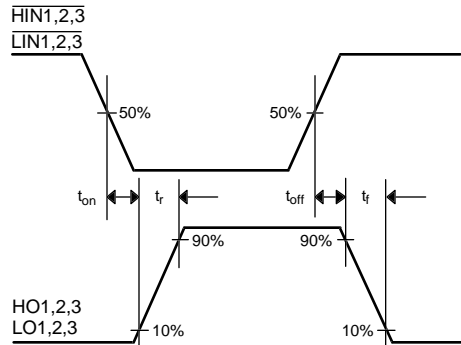
**Figure 1. Input/Output Timing Diagram**



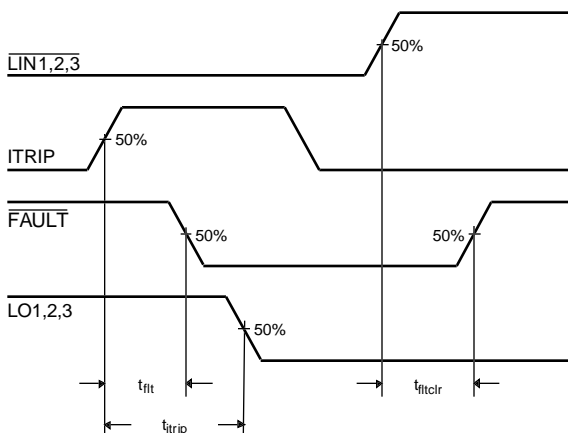
**Figure 2. Floating Supply Voltage Transient Test Circuit**



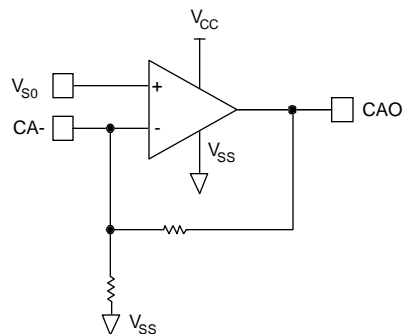
**Figure 3. Deadtime Waveform Definitions**



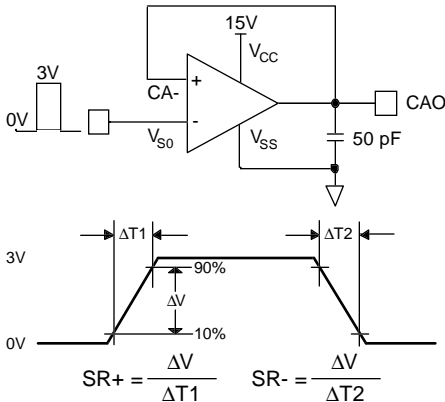
**Figure 4. Input/Output Switching Time Waveform Definitions**



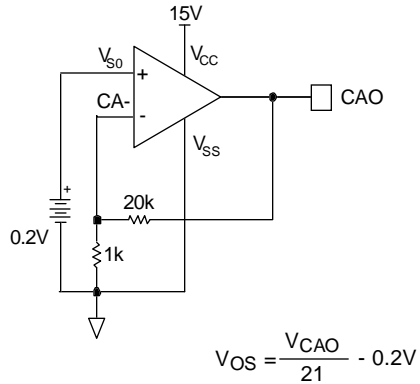
**Figure 5. Overcurrent Shutdown Switching Time Waveform Definitions**



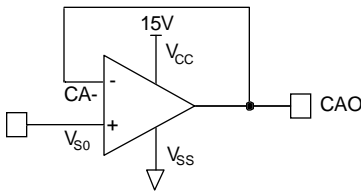
**Figure 6. Diagnostic Feedback Operational Amplifier Circuit**



**Figure 7. Operational Amplifier Slew Rate Measurement**



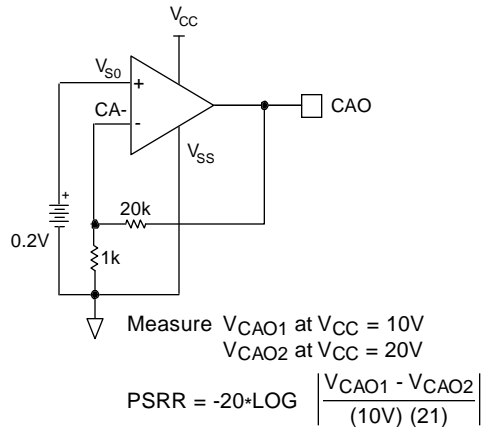
**Figure 8. Operational Amplifier Input Offset Voltage Measurement**



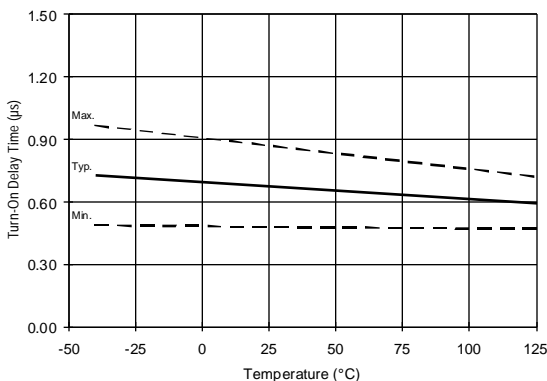
Measure  $V_{CAO1}$  at  $V_{S0} = 0.1V$   
 $V_{CAO2}$  at  $V_{S0} = 5V$

$$CMRR = -20 \cdot \text{LOG} \left| \frac{(V_{CAO1} - 0.1V) - (V_{CAO2} - 5V)}{4.9V} \right| \text{ (dB)}$$

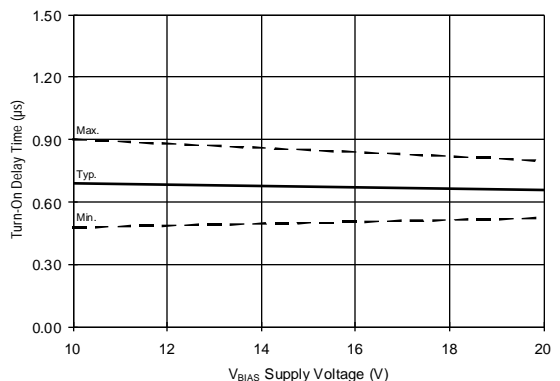
**Figure 9. Operational Amplifier Common Mode Rejection Ratio Measurements**



**Figure 10. Operational Amplifier Power Supply Rejection Ratio Measurements**



**Figure 11A. Turn-On Time vs. Temperature**



**Figure 11B. Turn-On Time vs. Voltage**



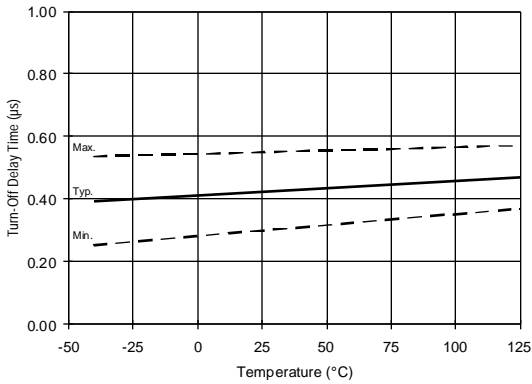


Figure 12A. Turn-Off Time vs. Temperature

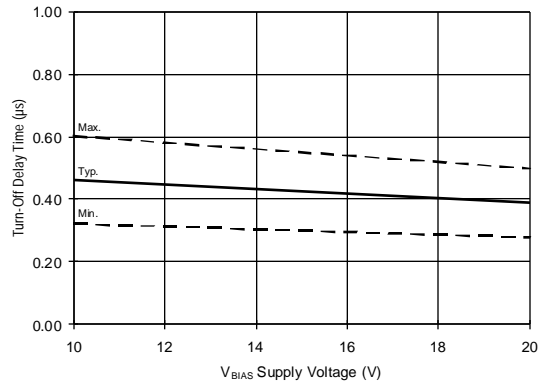


Figure 12B. Turn-Off Time vs. Voltage

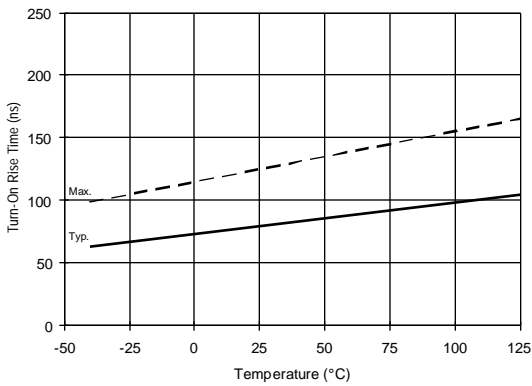


Figure 13A. Turn-On Rise Time vs. Temperature

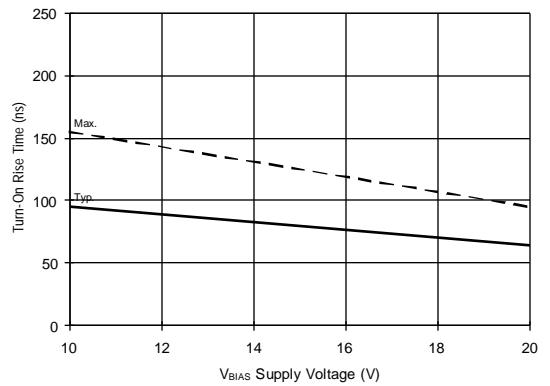


Figure 13B. Turn-On Rise Time vs. Voltage

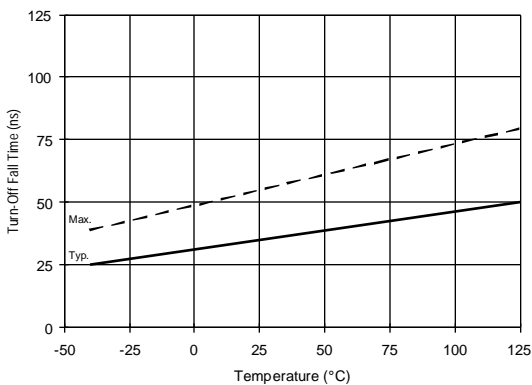


Figure 14A. Turn-Off Fall Time vs. Temperature

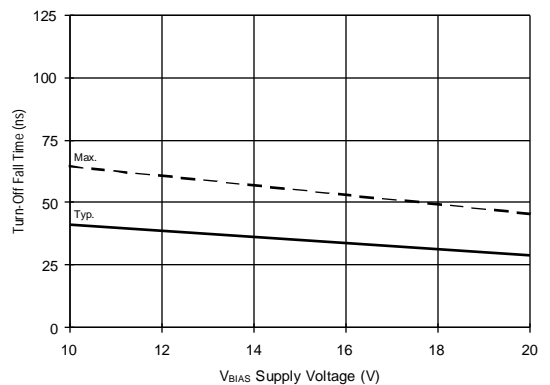
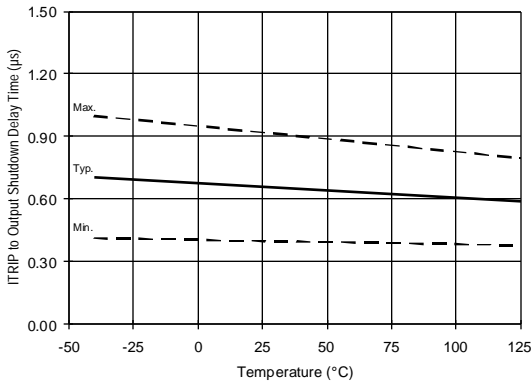
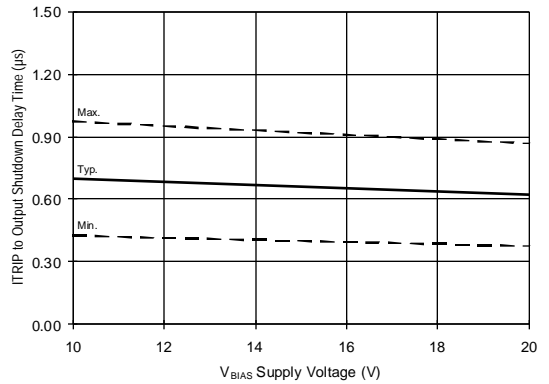


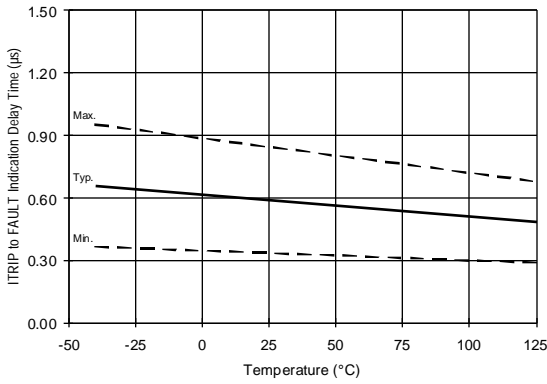
Figure 14B. Turn-Off Fall Time vs. Voltage



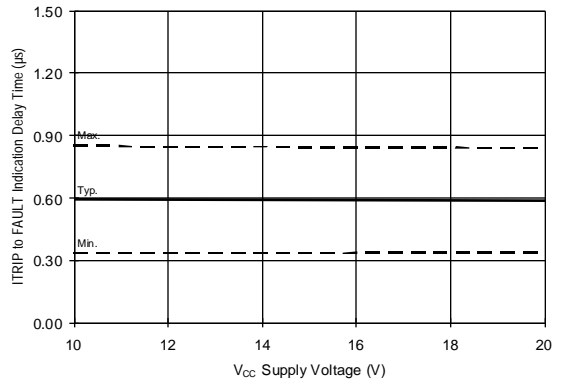
**Figure 15A. ITRIP to Output Shutdown Time vs. Temperature**



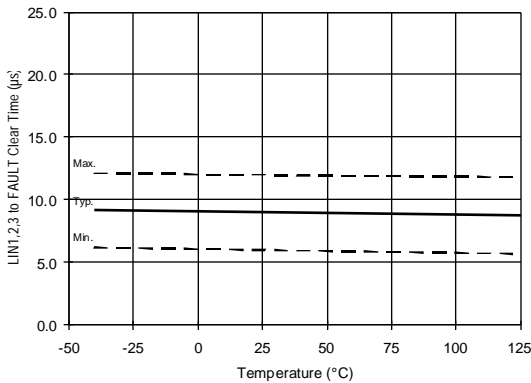
**Figure 15B. ITRIP to Output Shutdown Time vs. Voltage**



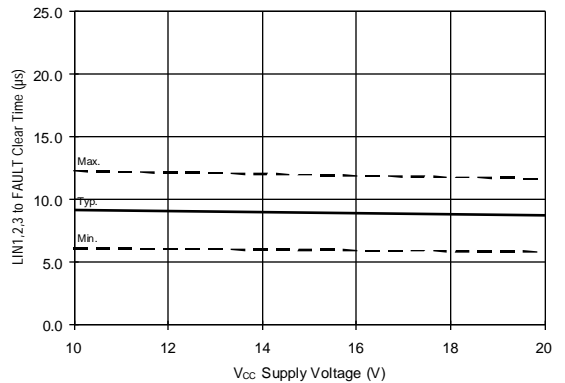
**Figure 16A. ITRIP to  $\overline{\text{FAULT}}$  Indication Time vs. Temperature**



**Figure 16B. ITRIP to  $\overline{\text{FAULT}}$  Indication Time vs. Voltage**



**Figure 17A.  $\overline{\text{LIN1,2,3}}$  to  $\overline{\text{FAULT}}$  Clear Time vs. Temperature**



**Figure 17B.  $\overline{\text{LIN1,2,3}}$  to  $\overline{\text{FAULT}}$  Clear Time vs. Voltage**

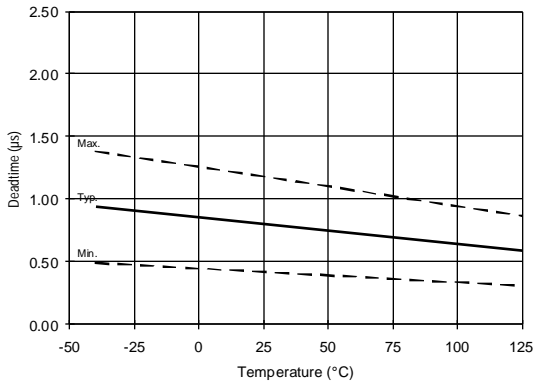


Figure 18A. Deadtime vs. Temperature

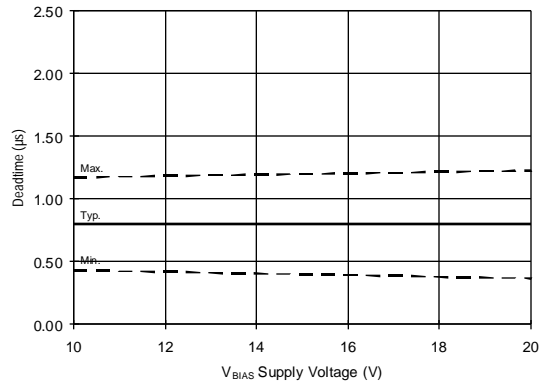


Figure 18B. Deadtime vs. Voltage

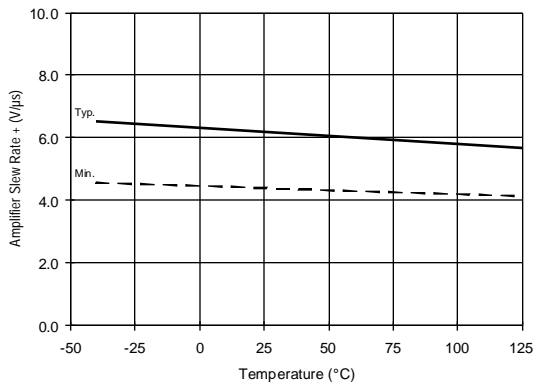


Figure 19A. Amplifier Slew Rate (+) vs. Temperature

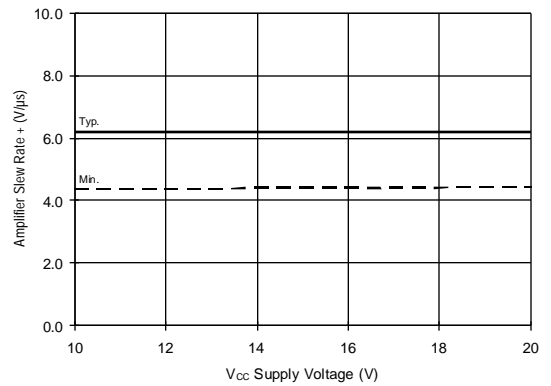


Figure 19B. Amplifier Slew Rate (+) vs. Voltage

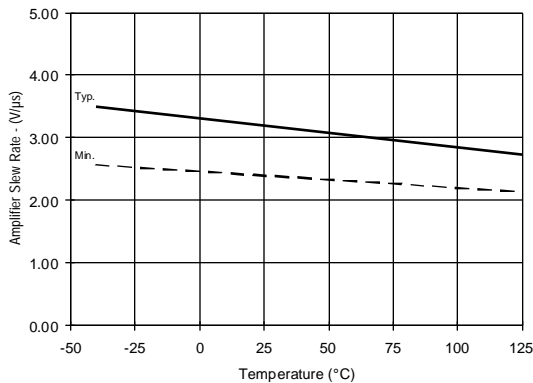


Figure 20A. Amplifier Slew Rate (-) vs. Temperature

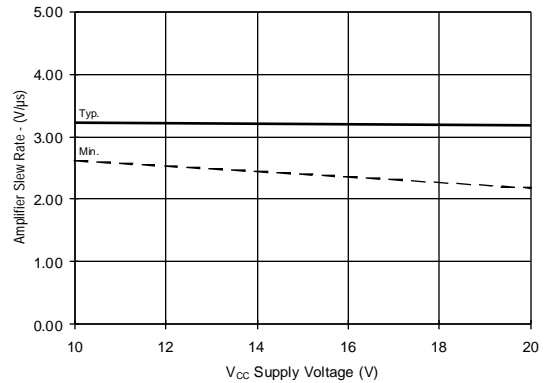
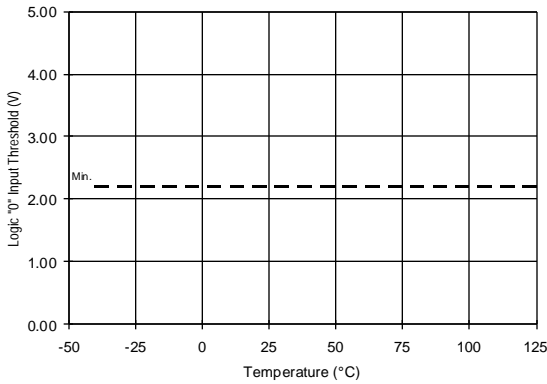
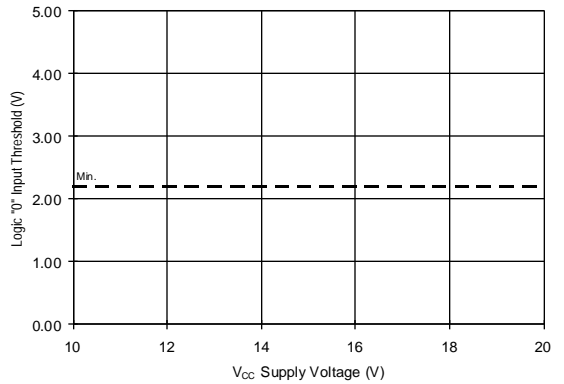


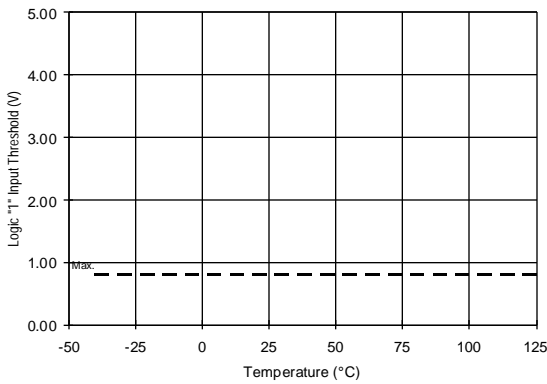
Figure 20B. Amplifier Slew Rate (-) vs. Voltage



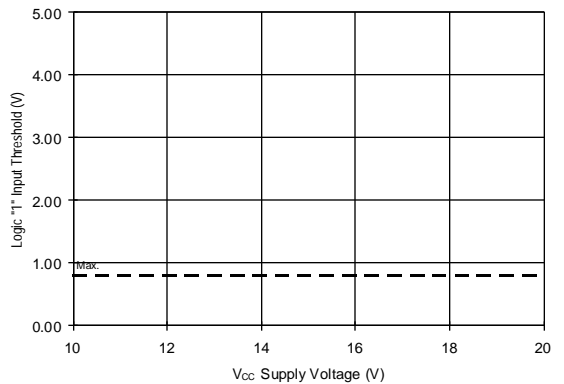
**Figure 21A. Logic "0" Input Threshold vs. Temperature**



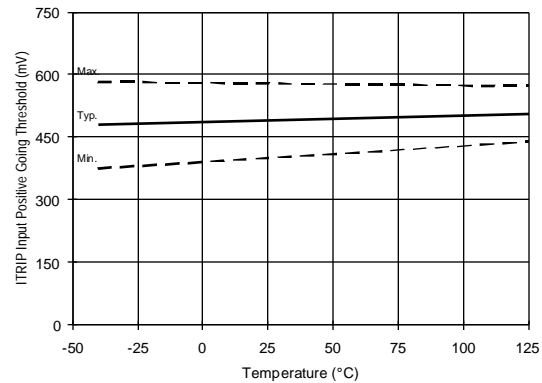
**Figure 20B. Logic "0" Input Threshold vs. Voltage**



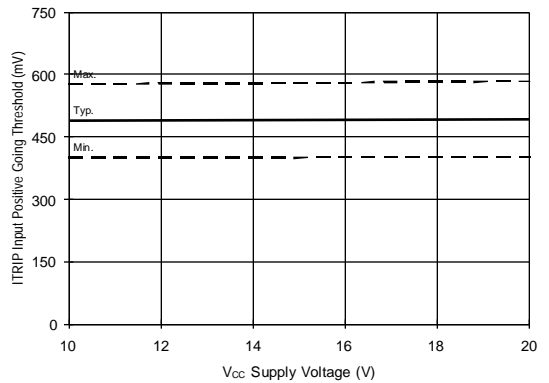
**Figure 22A. Logic "1" Input Threshold vs. Temperature**



**Figure 22B. Logic "1" Input Threshold vs. Voltage**



**Figure 23A. ITRIP Input Positive Going Threshold vs. Temperature**



**Figure 23B. ITRIP Input Positive Going Threshold vs. Voltage**

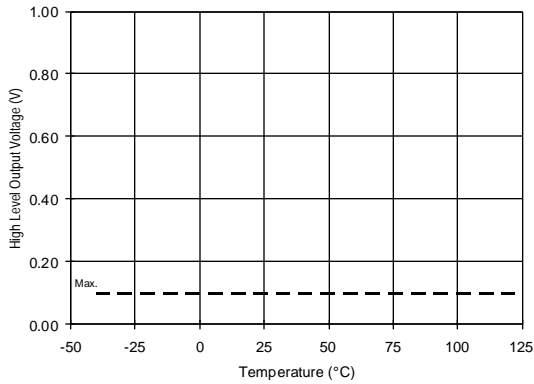


Figure 24A. High Level Output vs. Temperature

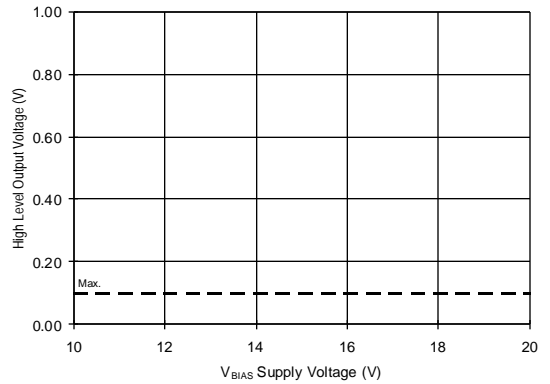


Figure 24B. High Level Output vs. Voltage

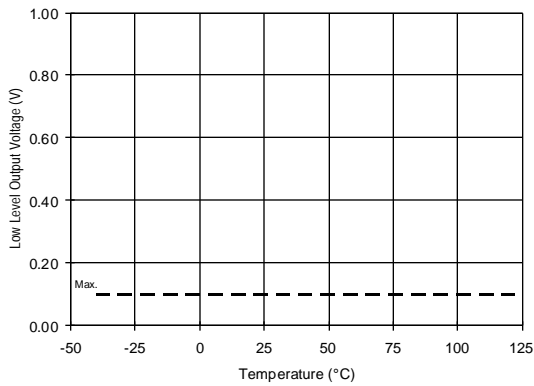


Figure 25A. Low Level Output vs. Temperature

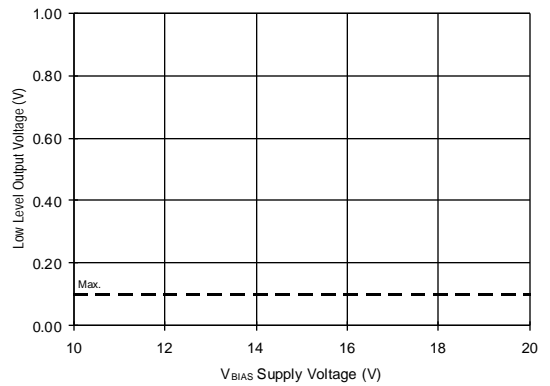


Figure 25B. Low Level Output vs. Voltage

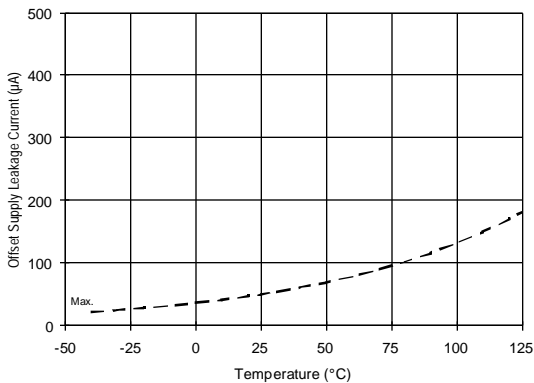


Figure 26A. Offset Supply Leakage Current vs. Temperature

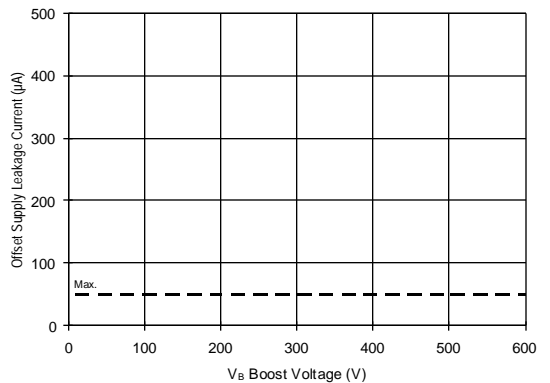
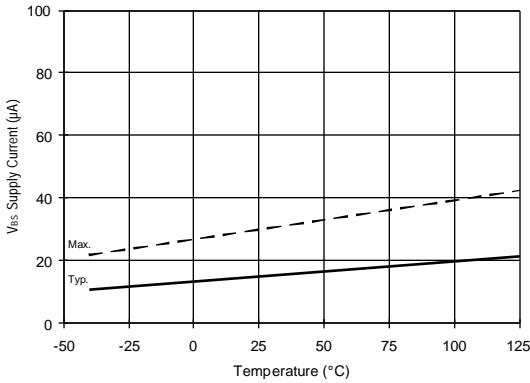
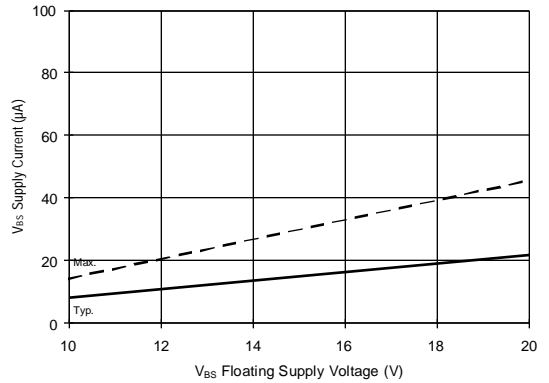


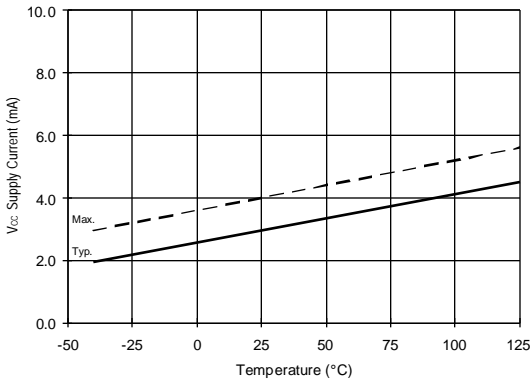
Figure 26B. Offset Supply Leakage Current vs. Voltage



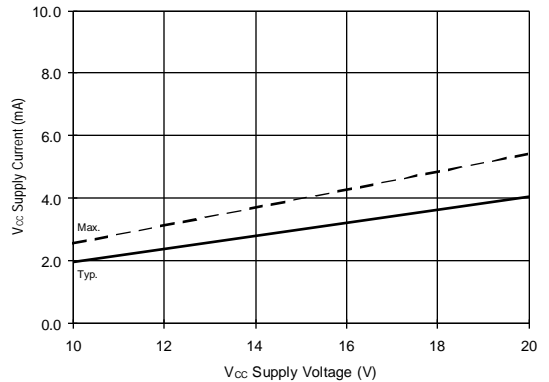
**Figure 27A. V<sub>BS</sub> Supply Current vs. Temperature**



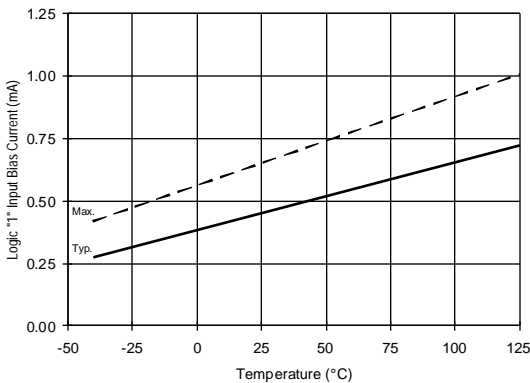
**Figure 27B. V<sub>BS</sub> Supply Current vs. Voltage**



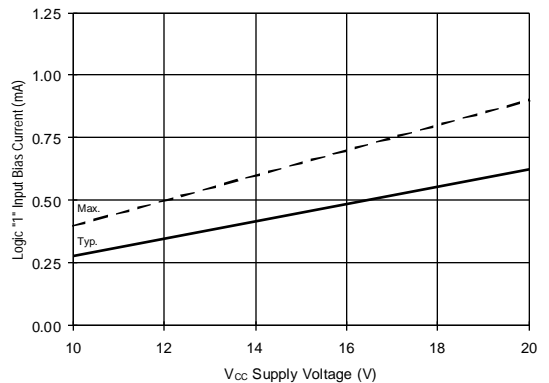
**Figure 28A. V<sub>CC</sub> Supply Current vs. Temperature**



**Figure 28B. V<sub>CC</sub> Supply Current vs. Voltage**



**Figure 29A. Logic "1" Input Current vs. Temperature**



**Figure 29B. Logic "1" Input Current vs. Voltage**

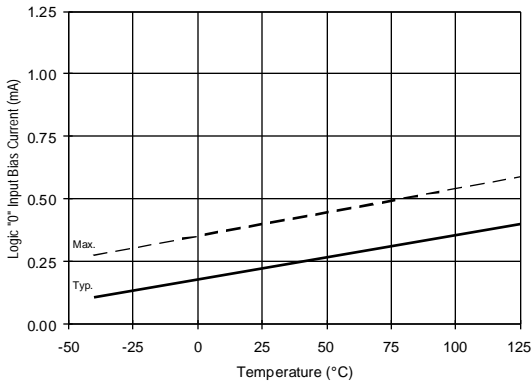


Figure 30A. Logic "0" Input Current vs. Temperature

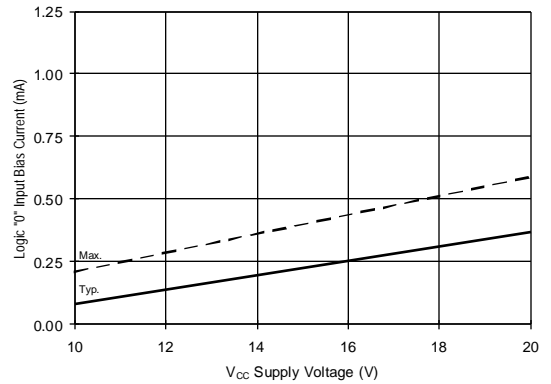


Figure 30B. Logic "0" Input Current vs. Voltage

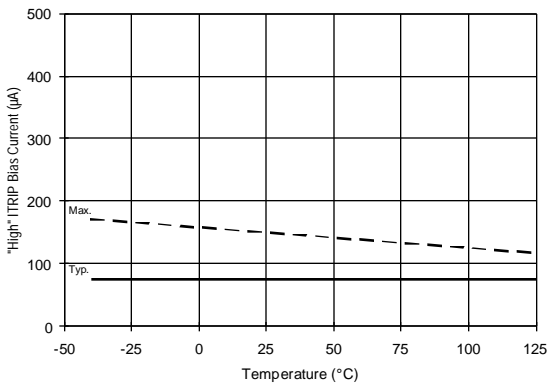


Figure 31A. "High" ITRIP Current vs. Temperature

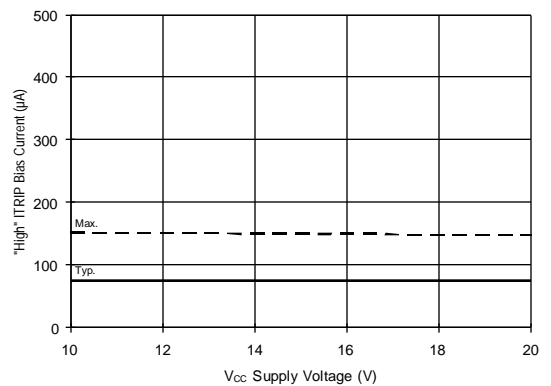


Figure 31B. "High" ITRIP Current vs. Voltage

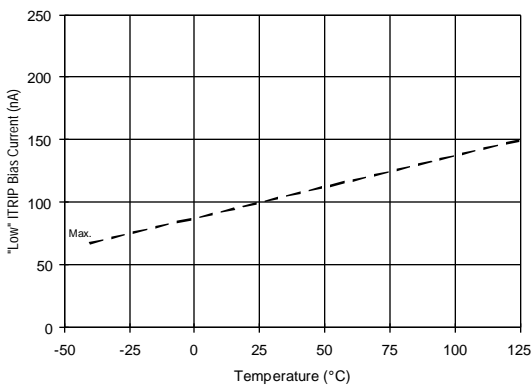


Figure 32A. "Low" ITRIP Current vs. Temperature

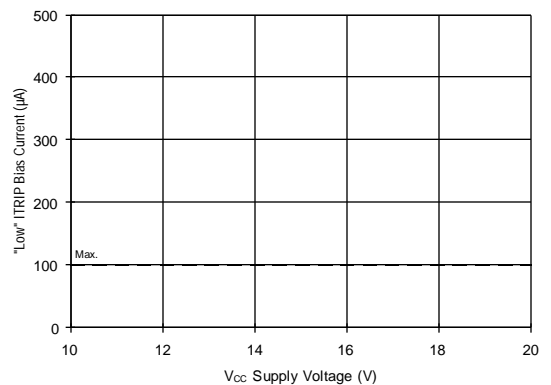
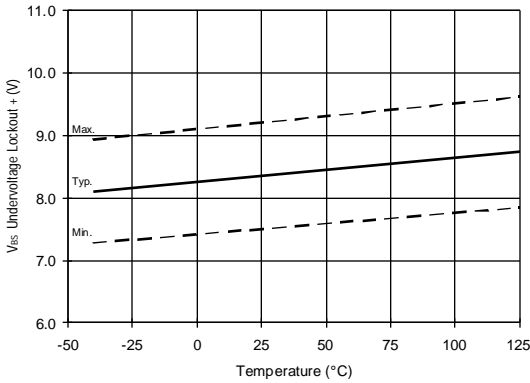
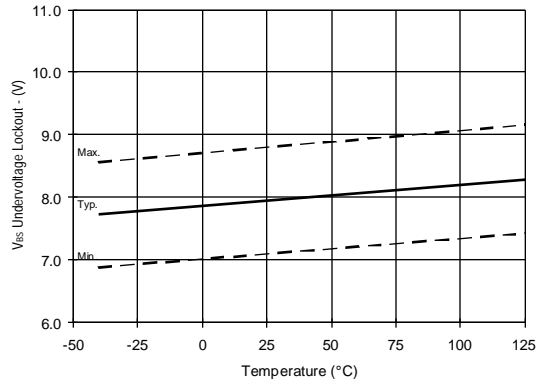


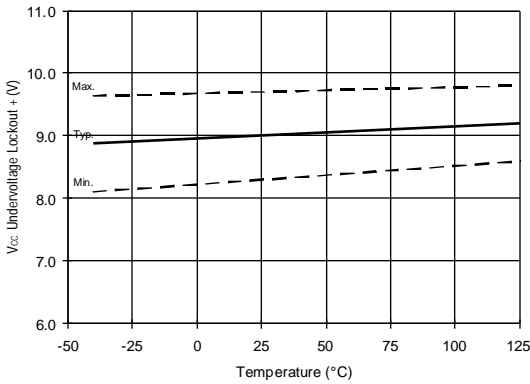
Figure 32B. "Low" ITRIP Current vs. Voltage



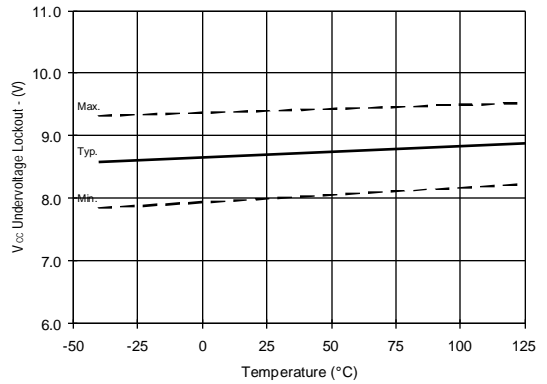
**Figure 33.  $V_{BS}$  Undervoltage (+) vs. Temperature**



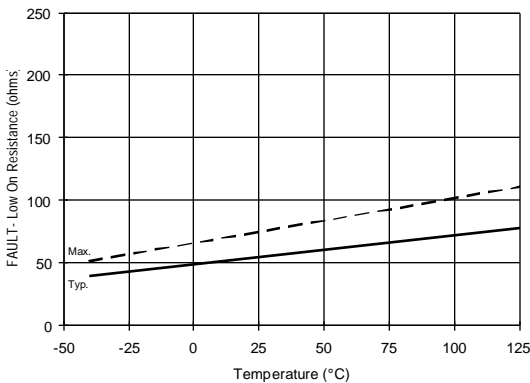
**Figure 34.  $V_{BS}$  Undervoltage (-) vs. Temperature**



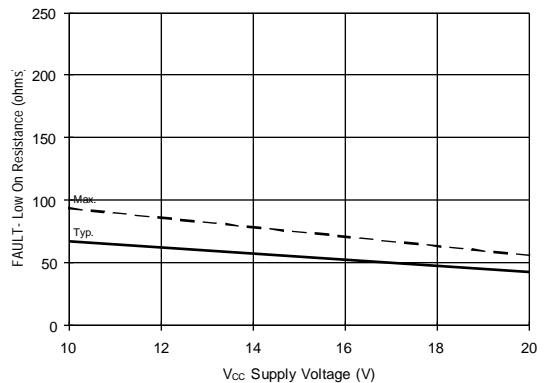
**Figure 35.  $V_{CC}$  Undervoltage (+) vs. Temperature**



**Figure 36.  $V_{CC}$  Undervoltage (-) vs. Temperature**



**Figure 37A.  $\overline{\text{FAULT}}$  Low On Resistance vs. Temperature**



**Figure 37B.  $\overline{\text{FAULT}}$  Low On Resistance vs. Voltage**



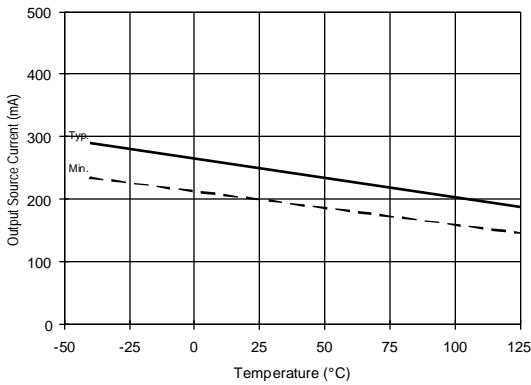


Figure 38A. Output Source Current vs. Temperature

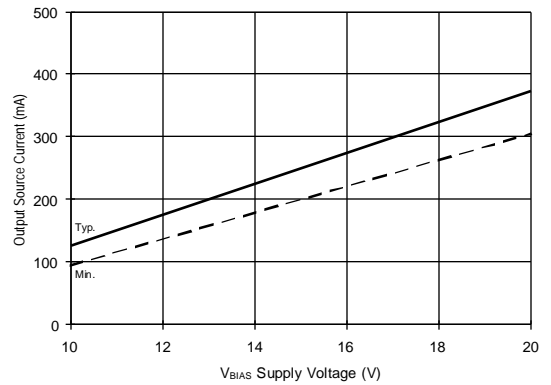


Figure 38B. Output Source Current vs. Voltage

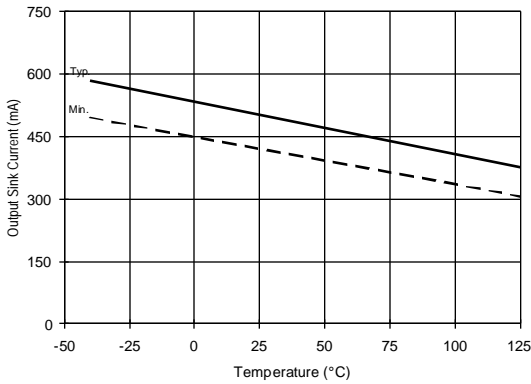


Figure 39A. Output Sink Current vs. Temperature

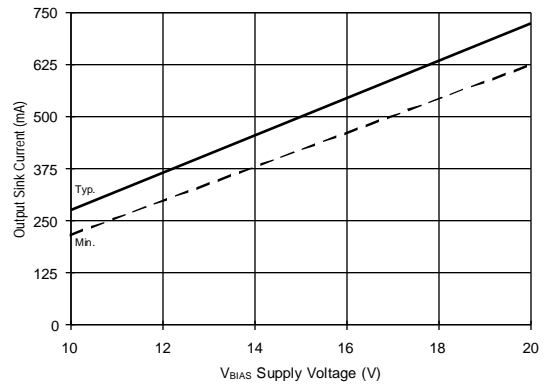


Figure 39B. Output Sink Current vs. Voltage

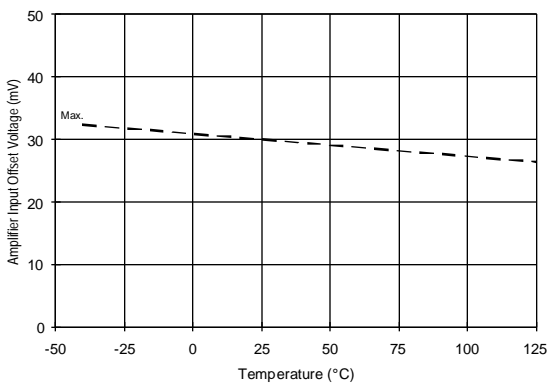


Figure 40A. Amplifier Input Offset vs. Temperature

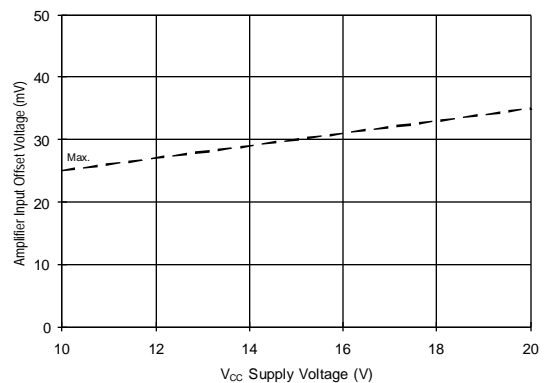
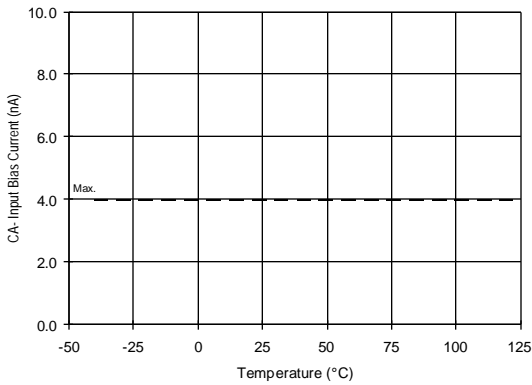
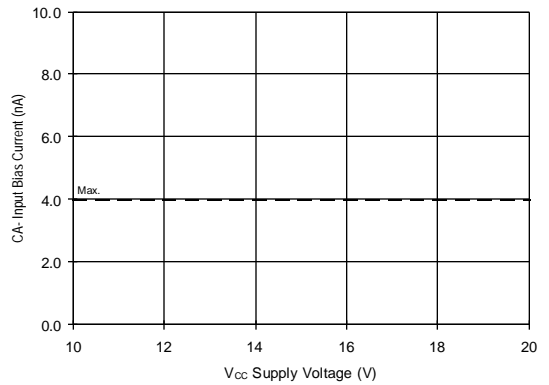


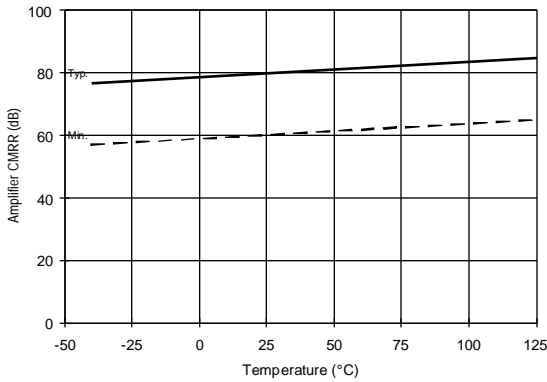
Figure 40B. Amplifier Input Offset vs. Voltage



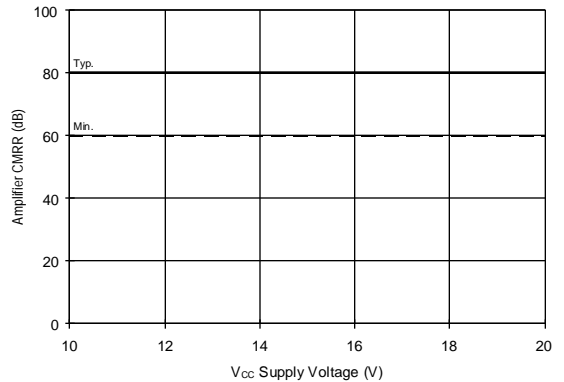
**Figure 41A. CA- Input Current vs. Temperature**



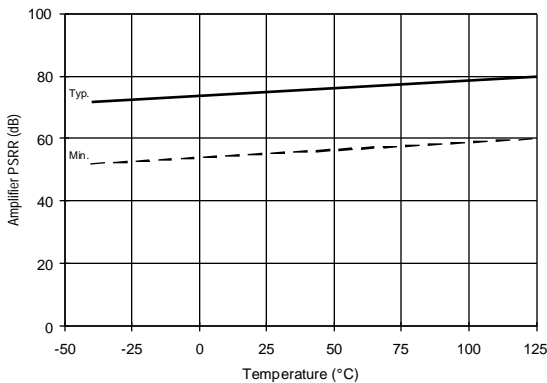
**Figure 41B. CA- Input Current vs. Voltage**



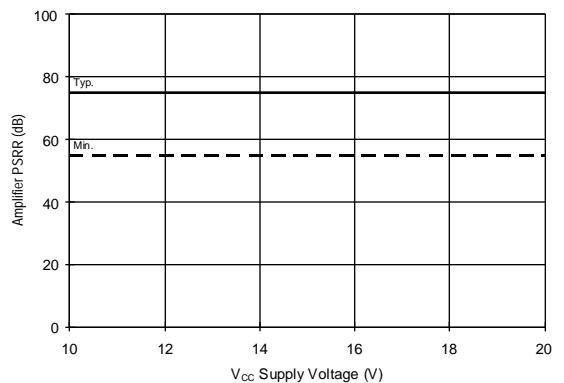
**Figure 42A. Amplifier CMRR vs. Temperature**



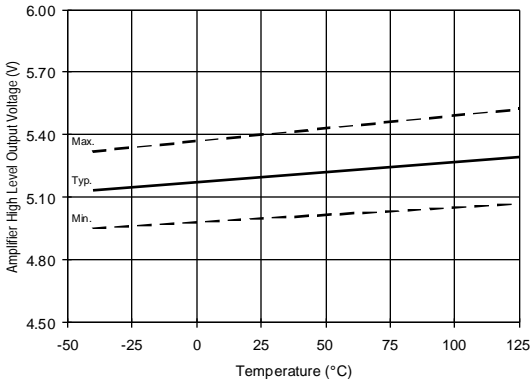
**Figure 42B. Amplifier CMRR vs. Voltage**



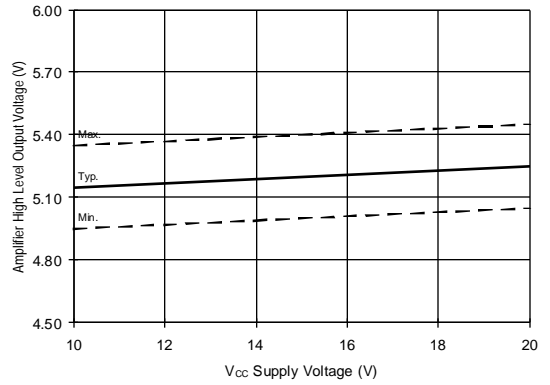
**Figure 43A. Amplifier PSRR vs. Temperature**



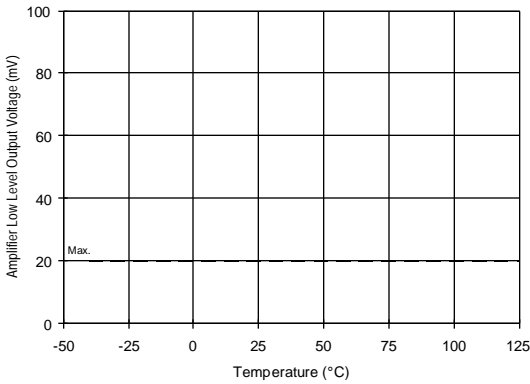
**Figure 43B. Amplifier PSRR vs. Voltage**



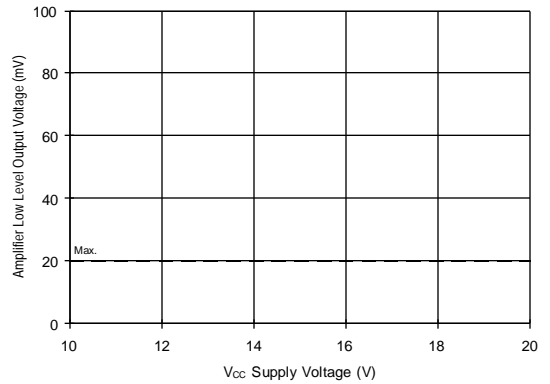
**Figure 44A. Amplifier High Level Output vs. Temperature**



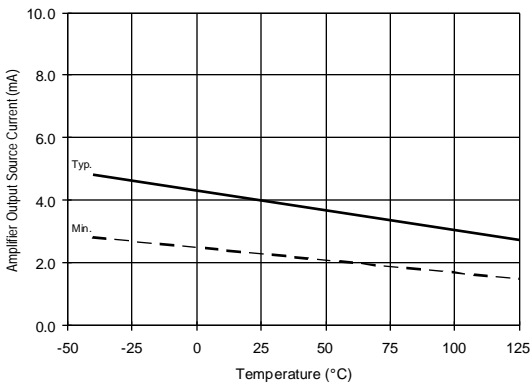
**Figure 44B. Amplifier High Level Output vs. Voltage**



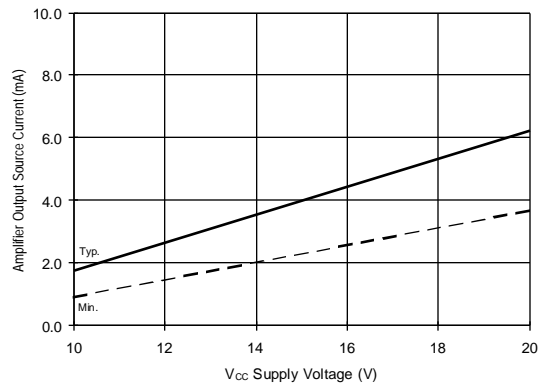
**Figure 45A. Amplifier Low Level Output vs. Temperature**



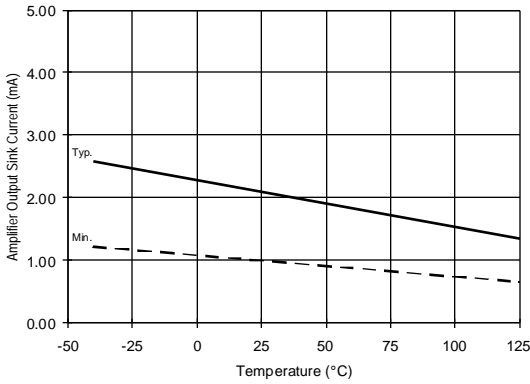
**Figure 45B. Amplifier Low Level Output vs. Voltage**



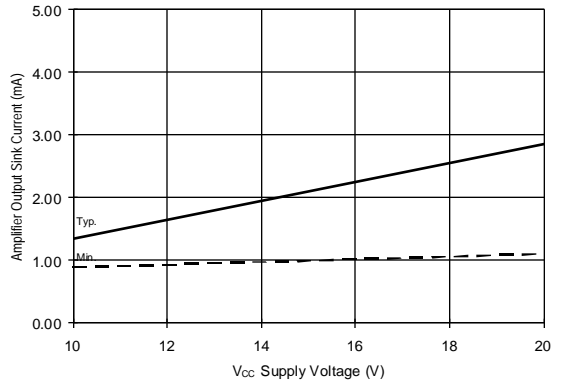
**Figure 46A. Amplifier Output Source Current vs. Temperature**



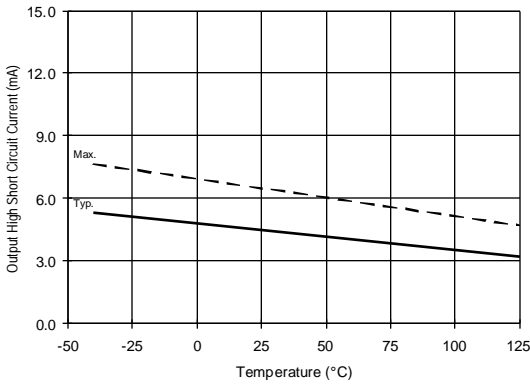
**Figure 46B. Amplifier Output Source Current vs. Voltage**



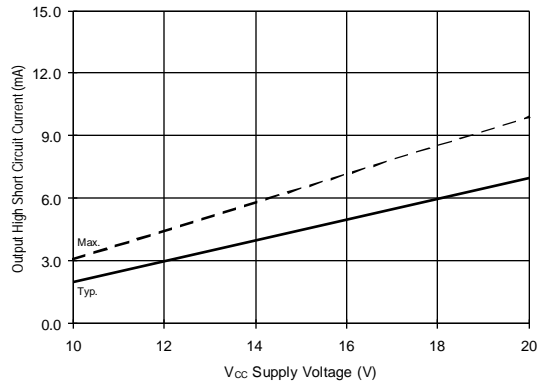
**Figure 47A. Amplifier Output Sink Current vs. Temperature**



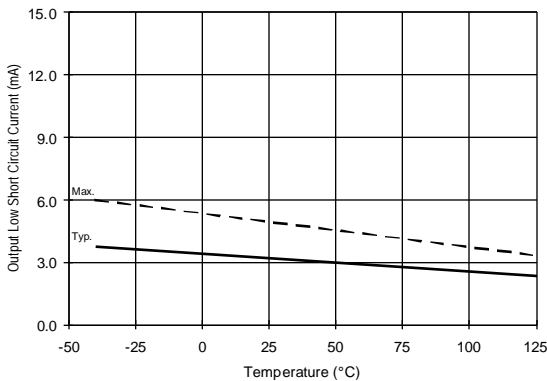
**Figure 47B. Amplifier Output Sink Current vs. Voltage**



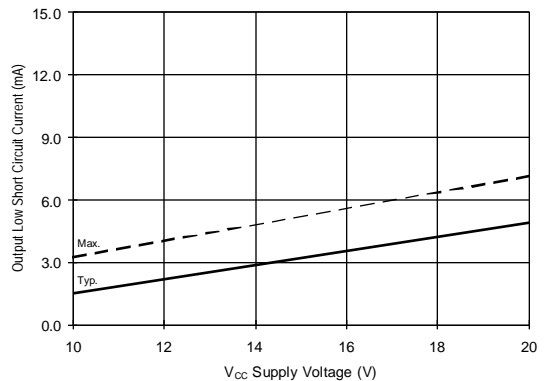
**Figure 48A. Amplifier Output High Short Circuit Current vs. Temperature**



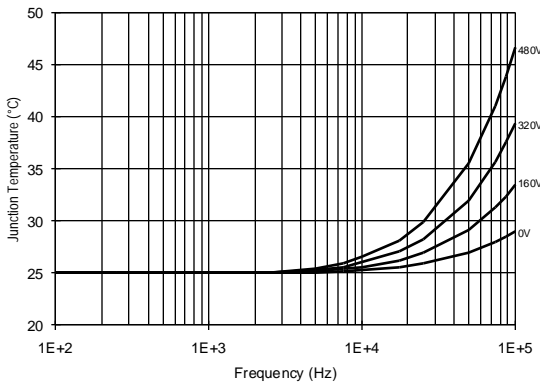
**Figure 48B. Amplifier Output High Short Circuit Current vs. Voltage**



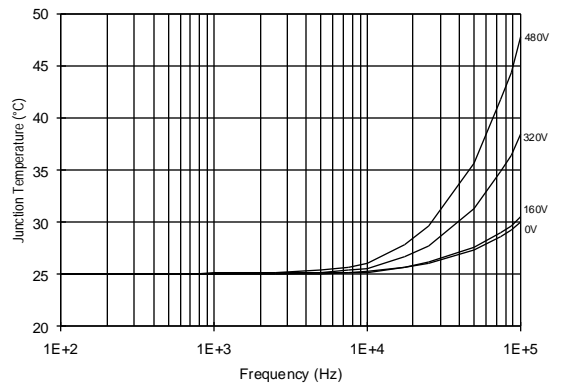
**Figure 49A. Amplifier Output Low Short Circuit Current vs. Temperature**



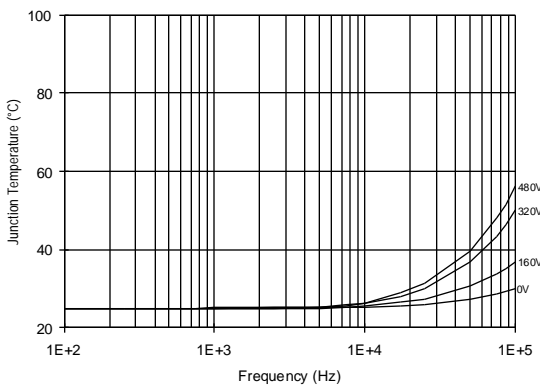
**Figure 49B. Amplifier Output Low Short Circuit Current vs. Voltage**



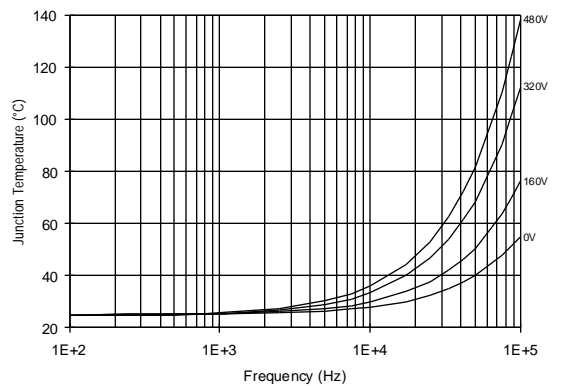
**Figure 50. IR2132  $T_J$  vs. Frequency (IRF820)**  
 $R_{GATE} = 33\Omega, V_{CC} = 15V$



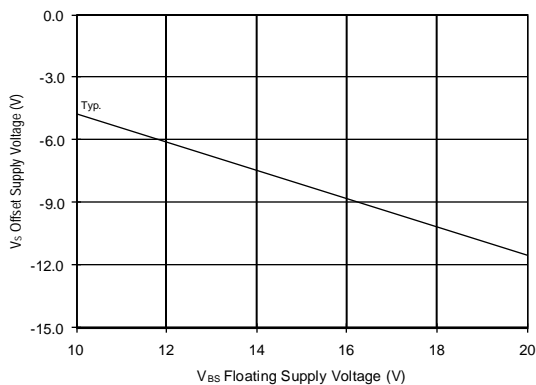
**Figure 51. IR2132  $T_J$  vs. Frequency (IRF830)**  
 $R_{GATE} = 20\Omega, V_{CC} = 15V$



**Figure 52. IR2132  $T_J$  vs. Frequency (IRF840)**  
 $R_{GATE} = 15\Omega, V_{CC} = 15V$



**Figure 53. IR2132  $T_J$  vs. Frequency (IRF450)**  
 $R_{GATE} = 10\Omega, V_{CC} = 15V$



**Figure 54. Maximum  $V_S$  Negative Offset vs.  $V_{BS}$  Supply Voltage**